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# United States Patent [19]

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Aoyama et al.

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## [54] SEMICONDUCTOR DEVICE HAVING A WIRING LAYER WITH A BARRIER LAYER

[75] Inventors: **Hisako Aoyama**, Kawasaki; **Kyoichi Suguro**, Yokohama; **Hiromi Niiyama**, Yokohama; **Hitoshi Tamura**, Yokohama; **Hisataka Hayashi**, Yokohama; **Tomonori Aoyama**; **Gaku Minamihaba**, both of Kawasaki; **Tadashi Iijima**, Yokohama, all of Japan

[73] Assignee: **Kabushiki Kaisha Toshiba**, Kawasaki, Japan

[21] Appl. No.: **330,998**

[22] Filed: **Oct. 28, 1994**

### [30] Foreign Application Priority Data

Oct. 29, 1993	[JP]	Japan	.....	5-272784
Mar. 15, 1994	[JP]	Japan	.....	6-070156
Sep. 19, 1994	[JP]	Japan	.....	6-249984

[51] Int. Cl.<sup>6</sup> ..... **H01L 23/535**; H01L 29/41; H01L 29/43

[52] U.S. Cl. .... **257/751**; 257/752; 257/760; 257/763; 257/764; 257/762; 257/915

[58] Field of Search ..... 257/750-753, 257/759, 760, 762, 773, 763, 764, 915

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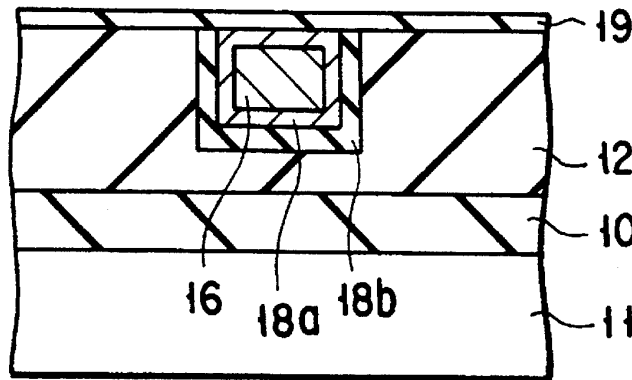
*Primary Examiner*—Peter Toby Brown

*Attorney, Agent, or Firm*—Oblon, Spivak, McClelland, Maier & Neustadt, P.C.

### [57] ABSTRACT

A semiconductor device comprises a semiconductor substrate in which a semiconductor element is formed, an interlayer insulating film formed on the semiconductor substrate, an insulating barrier layer, formed on the interlayer insulating film by plasma nitriding, for preventing diffusion of a metal constituting a wiring layer, a conductive barrier layer, formed on the insulating barrier layer, for preventing diffusion of the metal, and a wiring layer formed of the metal on the conductive barrier layer. A bottom portion of the wiring layer is protected by the conductive barrier layer and the insulating barrier layer. Therefore, the diffusion of the metal constituting the wiring layer can be surely prevented.

**5 Claims, 35 Drawing Sheets**



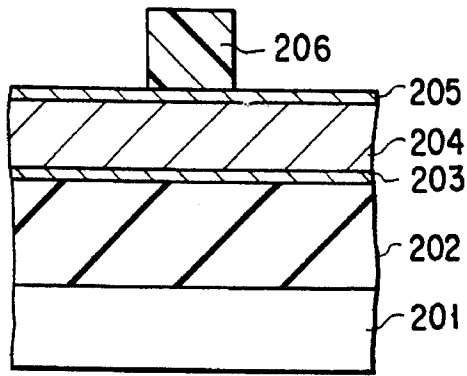


FIG. 1A PRIOR ART

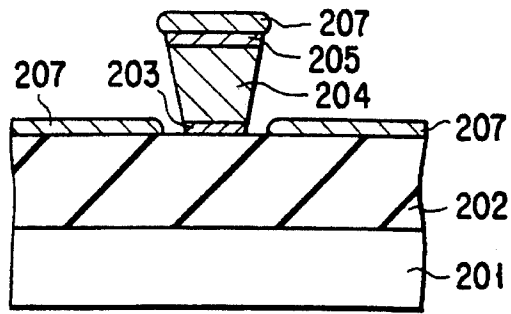


FIG. 2A PRIOR ART

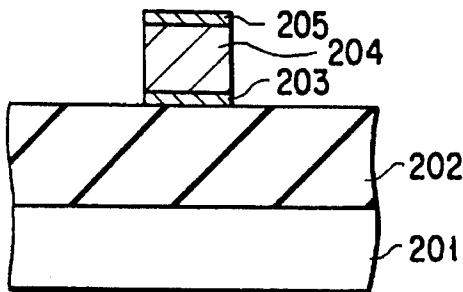


FIG. 1B PRIOR ART

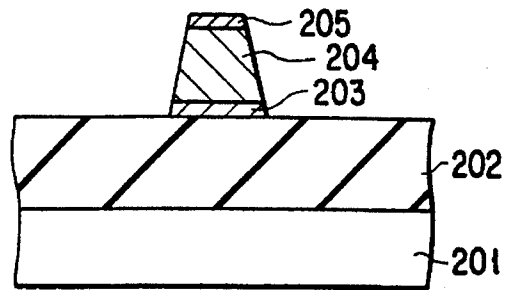


FIG. 2B PRIOR ART

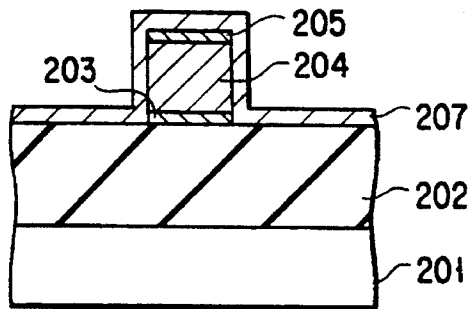


FIG. 1C PRIOR ART

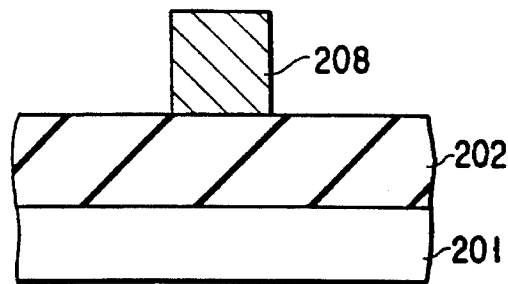


FIG. 3A PRIOR ART

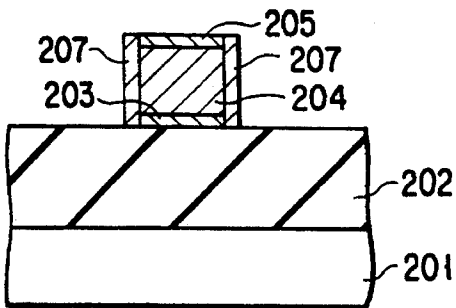


FIG. 1D PRIOR ART

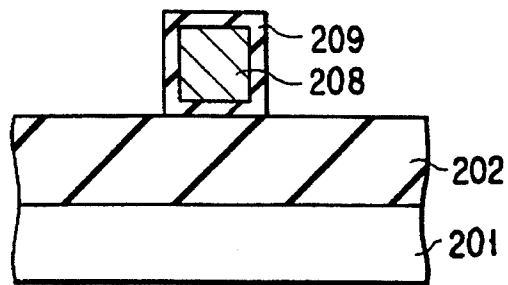


FIG. 3B PRIOR ART

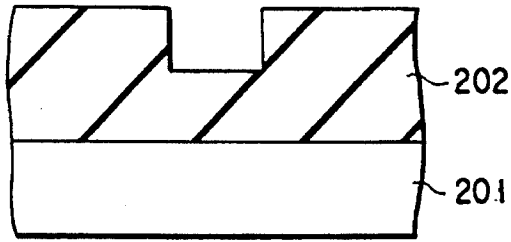


FIG. 4A PRIOR ART

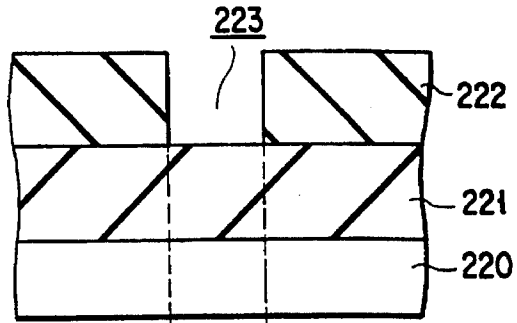


FIG. 5A PRIOR ART

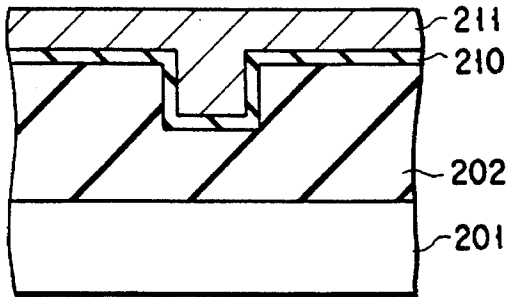


FIG. 4B PRIOR ART

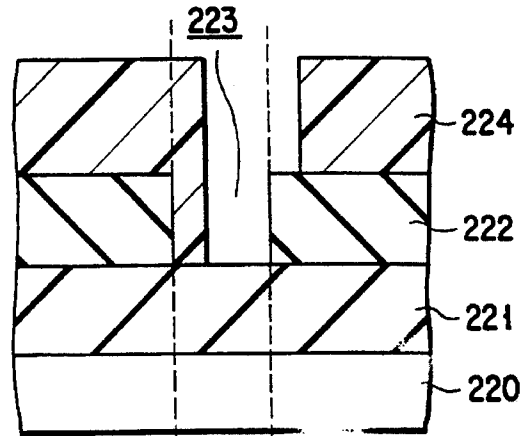


FIG. 5B PRIOR ART

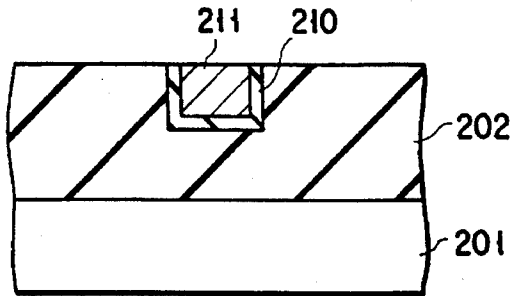


FIG. 4C PRIOR ART

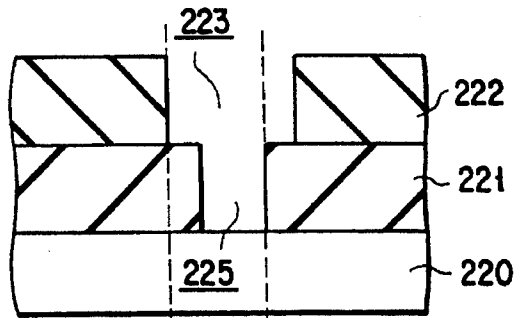


FIG. 5C PRIOR ART

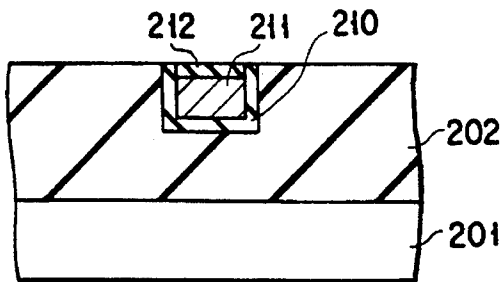


FIG. 4D PRIOR ART

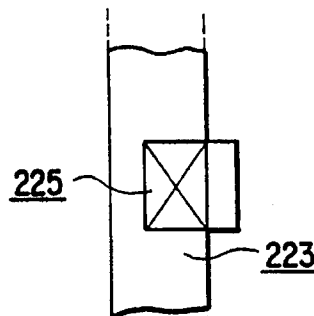
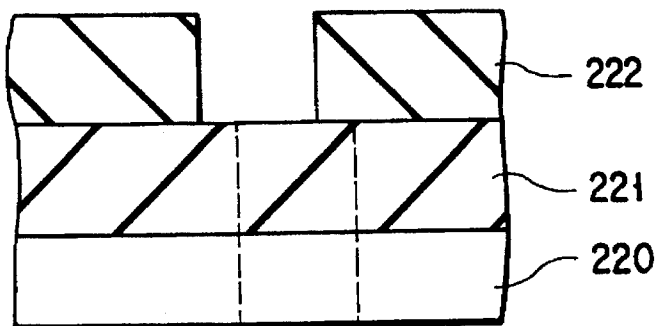
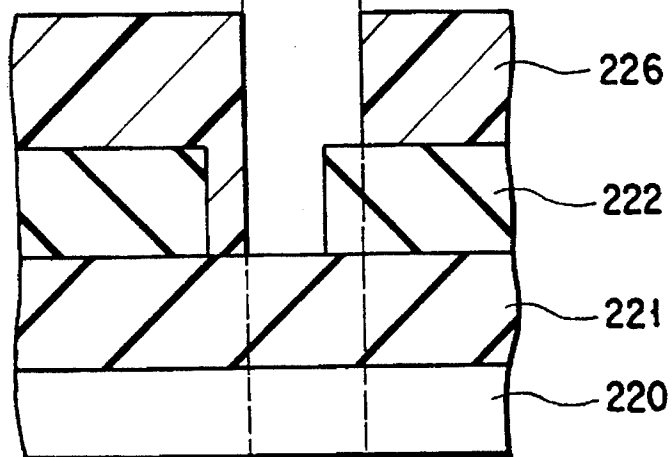


FIG. 5D PRIOR ART

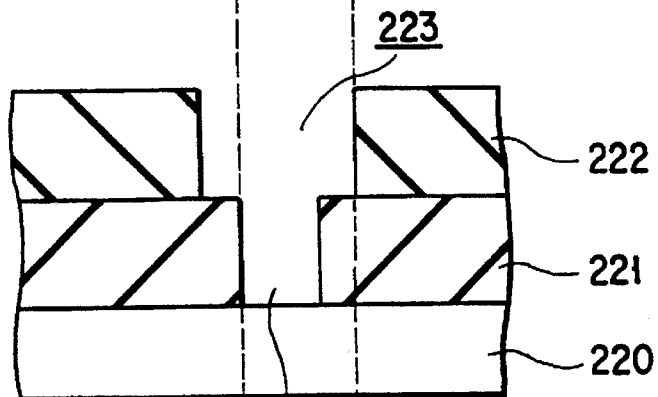
PRIOR ART  
FIG. 6A



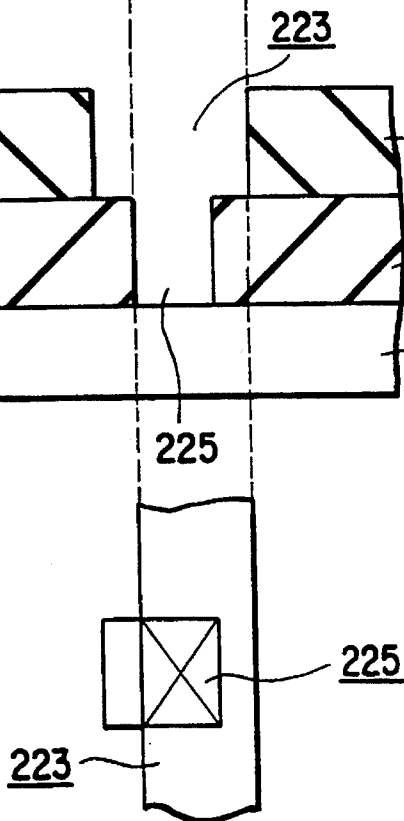
PRIOR ART  
FIG. 6B



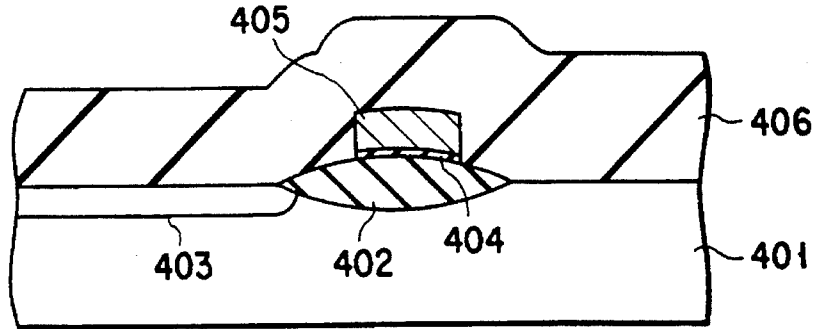
PRIOR ART  
FIG. 6C



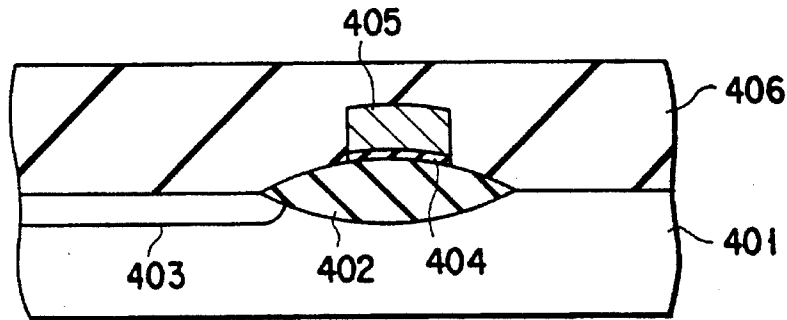
PRIOR ART  
FIG. 6D



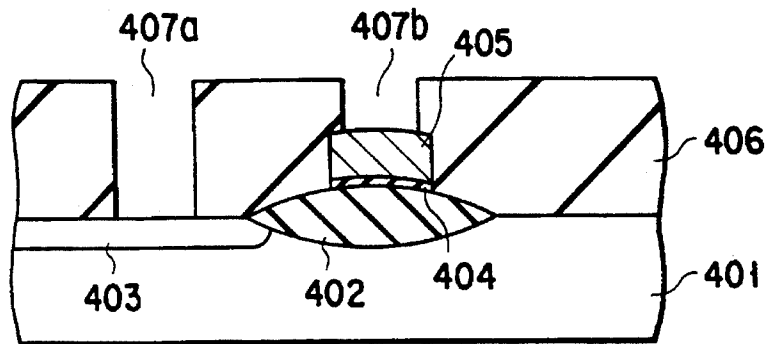
PRIOR ART  
FIG. 7A



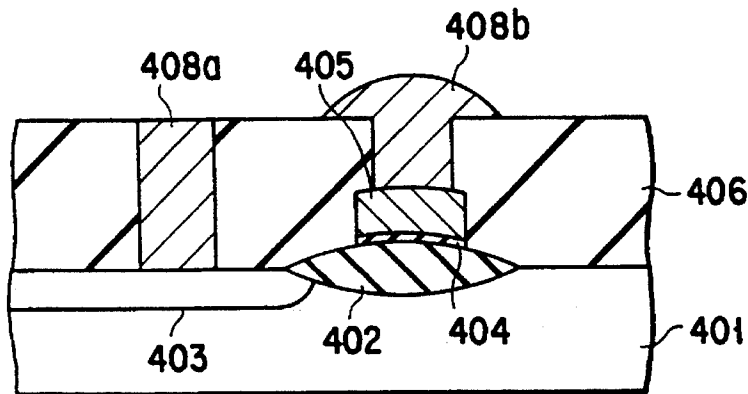
PRIOR ART  
FIG. 7B



PRIOR ART  
FIG. 7C



PRIOR ART  
FIG. 7D



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